

IMPACT

TE Internal #: 2007809-1

High Speed Backplane Connectors, 120 Position, Mating Alignment, Keyed Mating Alignment Type, 12 Row, 10 Column,

PCB Mount Header, Vertical, IMPACT

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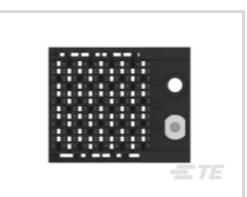


Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors











Connector System: Board-to-Board

Number of Positions: 120

Row-to-Row Spacing: 1.35 mm [.053 in]

Mating Alignment: With

Mating Alignment Type: Keyed

Features

Product Type Features

Signal Arrangement	Differential	
Connector System	Board-to-Board	
PCB Connector Assembly Type	PCB Mount Header	
Shroud Style	Partially Shrouded	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Ground Positions	40	
Number of Pairs	40	
Stackable	No	
Number of Signal Positions	80	
Number of Positions	120	
Number of Rows	12	
Number of Columns	10	
PCB Mount Orientation	Vertical	



Guide Location	Left	
Electrical Characteristics		
Impedance	100 Ω	
Operating Voltage	30 VAC	
Signal Characteristics		
Number of Differential Pairs per Column	4	
Data Rate	20 – 25 Gb/s	
Body Features		
Primary Product Color	Black	
Contact Features		
Contact Mating Area Length	4.5 mm[.177 in]	
PCB Contact Termination Area Plating Material Thickness	.76 – 1.52 μm[30 – 60 μin]	
Contact Layout	Inline	
Contact Type	Pin	
Contact Underplating Material Thickness	1.27 μm[50 μin]	
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]	
Contact Mating Area Plating Material	Gold	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	& Form Dual Beam	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	ermination Area Plating Material Tin	
Contact Base Material	Copper Alloy	
Contact Current Rating (Max)	.75 A	
Termination Features		
Termination Post & Tail Length	1.4 mm[.055 in]	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit	
Mechanical Attachment		
Guide Hardware	With	
Mating Retention	Without	
PCB Mount Retention	With	
PCB Mount Retention Type	Action/Compliant Tail & Screw	
Mating Alignment	With	



Mating Alignment Type	Keyed	
Connector Mounting Type	Board Mount	
Housing Features		
Number of Shrouded Sides	2	
End Wall Location	Open	
Housing Material	LCP - GF (Liquid Crystal Polymer)	
Centerline (Pitch)	1.9 mm[.075 in]	
Dimensions		
Connector Length	25.5 mm[1.004 in]	
Connector Height	24.6 mm[.969 in]	
Connector Width	20.8 mm[.819 in]	
PCB Thickness (Recommended)	1 mm	
PCB Hole Diameter	.39 mm[.015 in]	
Row-to-Row Spacing	1.35 mm[.053 in]	
Usage Conditions		
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Compatible With Approved Standards Products	CSA Certified, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Method	Box & Tube, Tube	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235)



		REACH	CV/II/C
$n \cap T$	CONTAIN	RFA(H	$\sim VH($

· ·	gen - Br, Cl, F, I < 900 ppm per ous material. Also BFR/CFR/PVC
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Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

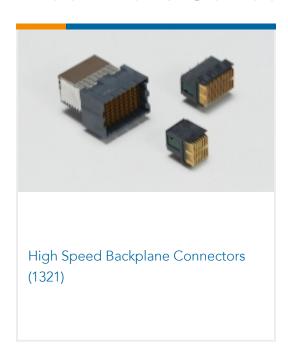
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | IMPACT



Customers Also Bought





TE Part #5120521-1 1FHR,64,30A/S,S,N,S08,09,10



TE Part #2102771-1 DC, 7Row, Center, MULTIGIG RT 2R



TE Part #1-1469492-8
MULTIGIG RT 9MM GUIDE/ESD 315
DEG





TE Part #1410142-1
MULTIGIG RT T2 .8" BP FULL RGH







Documents

Product Drawings

IMP100S,H,V4P10C,LG,OEW39,4.5

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2007809-1_A_c-2007809-1-a.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2007809-1_A_c-2007809-1-a.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2007809-1_A_c-2007809-1-a.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

7-1773458-1_IMPACT_BACKPLANE_CONNECTOR_SYSTEM_CATALOG

English

Product Specifications

Application Specification

English

Agency Approvals

Agency Approval Document

High Speed Backplane Connectors, 120 Position, Mating Alignment, Keyed Mating Alignment Type, 12 Row, 10 Column, PCB Mount Header, Vertical, IMPACT



English